

Features

- Advanced high cell density Trench technology
- Super Low Gate Charge
- Excellent CdV/dt effect decline
- 100% EAS Guaranteed
- Green Device Available

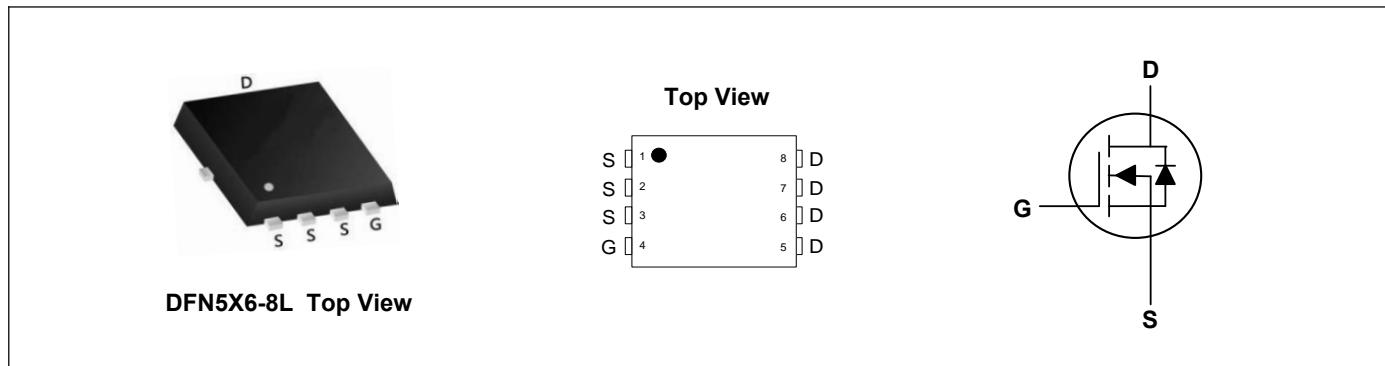
Product Summary



V_{DS}	80	V
I_D	150	A
$R_{DS(ON)}$ Typ (at $V_{GS}=10V$)	1.8	mΩ

Applications

- High Frequency Point-of-Load,Synchronous Buck Converter
- Networking DC-DC Power System
- Load Switch



Absolute Maximum Ratings($T_c=25^\circ\text{C}$, unless otherwise noted)

Parameter	Symbol	Rating	Units
Drain-Source Voltage	V_{DS}	80	V
Gate-Source Voltage	V_{GS}	± 20	V
Continuous Drain Current ¹	$I_D @ T_c=25^\circ\text{C}$	150	A
Pulsed Drain Current ²	I_{DM}	600	A
Single Pulse Avalanche Energy ³	E_{AS}	841	mJ
Total Power Dissipation ⁴	P_D	167	W
Storage Temperature Range	T_{STG}	-55 to 150	°C
Operating Junction Temperature Range	T_J	-55 to 150	°C

Thermal Characteristics

Parameter	Symbol	Typ	Max	Unit
Thermal Resistance Junction-Ambient ¹	$R_{\theta JA}$	---	50	°C/W
Thermal Resistance Junction-Case ¹	$R_{\theta JC}$	---	0.9	°C/W

Electrical Characteristics ($T_J=25^\circ\text{C}$, unless otherwise noted)

Parameter	Symbol	Conditions	Min	Typ	Max	Unit
Drain-Source Breakdown Voltage	BV_{DSS}	$V_{\text{GS}}=0\text{V}$, $I_D=250\mu\text{A}$	80	---	---	V
Static Drain-Source On-Resistance	$R_{\text{DS}(\text{ON})}$	$V_{\text{GS}}=10\text{V}$, $I_D=15\text{A}$	---	1.8	2.2	$\text{m}\Omega$
Gate Threshold Voltage	$V_{\text{GS}(\text{th})}$	$V_{\text{GS}}=V_{\text{DS}}$, $I_D=250\mu\text{A}$	2.0	---	4.0	V
Drain-Source Leakage Current	I_{DSS}	$V_{\text{DS}}=80\text{V}$, $V_{\text{GS}}=0\text{V}$, $T_J=25^\circ\text{C}$	---	---	1	uA
Gate-Source Leakage Current	I_{GSS}	$V_{\text{GS}}=\pm 20\text{V}$, $V_{\text{DS}}=0\text{V}$	---	---	± 100	nA
Gate Resistance	R_g	$V_{\text{DS}}=0\text{V}$, $V_{\text{GS}}=0\text{V}$, $f=1\text{MHz}$	---	1.03	---	Ω
Total Gate Charge	Q_g	$V_{\text{DS}}=40\text{V}$, $V_{\text{GS}}=10\text{V}$, $I_D=20\text{A}$	---	113	---	nC
Gate-Source Charge	Q_{gs}		---	24	---	
Gate-Drain Charge	Q_{gd}		---	16	---	
Turn-On Delay Time	$T_{\text{d}(\text{on})}$	$V_{\text{DS}}=40\text{V}$, $V_{\text{GS}}=10\text{V}$, $R_G=1\Omega$, $I_D=20\text{A}$	---	22	---	ns
Rise Time	T_r		---	35	---	
Turn-Off Delay Time	$T_{\text{d}(\text{off})}$		---	52	---	
Fall Time	T_f		---	19	---	
Input Capacitance	C_{iss}	$V_{\text{DS}}=40\text{V}$, $V_{\text{GS}}=0\text{V}$, $f=1\text{MHz}$	---	5840	---	pF
Output Capacitance	C_{oss}		---	776	---	
Reverse Transfer Capacitance	C_{rss}		---	19	---	

Drain-Source Diode Characteristics

Parameter	Symbol	Conditions	Min	Typ	Max	Unit
Diode Forward Voltage ²	V_{SD}	$V_{\text{GS}}=0\text{V}$, $I_F=20\text{A}$, $T_J=25^\circ\text{C}$	---	0.8	1.1	V
Reverse recovery time	t_{rr}	$I_F=20\text{A}$, $dI/dt=100\text{A}/\mu\text{s}$	---	50	---	ns
Reverse recovery charge	Q_{rr}		---	100	---	nC
Peak reverse recovery current	I_{rrm}		---	3.06	---	A

Note:

1. The data tested by surface mounted on a 1 inch² FR-4 board with 2OZ copper.
2. The data tested by pulsed, pulse width $\leq 300\mu\text{s}$, duty cycle $\leq 2\%$
3. The EAS data shows Max. rating. The test condition is $V_{\text{DD}}=50\text{V}$, $V_{\text{GS}}=10\text{V}$, $L=0.5\text{mH}$
4. The power dissipation is limited by 150°C junction temperature

Typical Characteristics

Diagram 1: Power dissipation

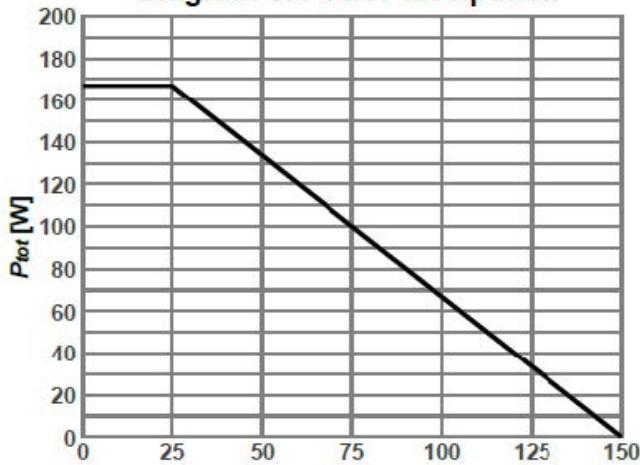


Diagram 2: Typ. output characteristics

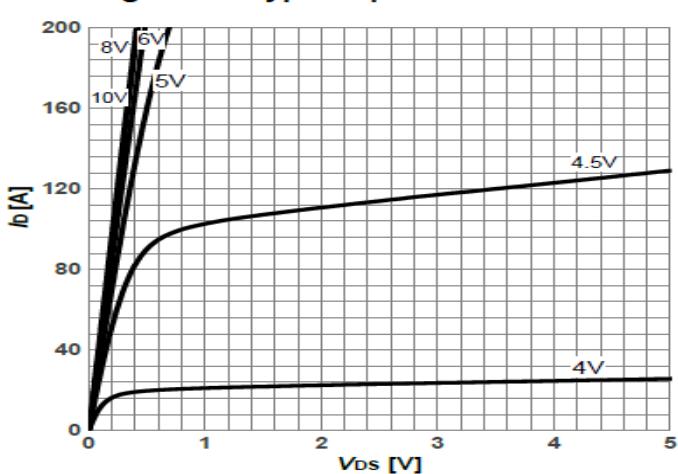


Diagram 3: Typ. output characteristics

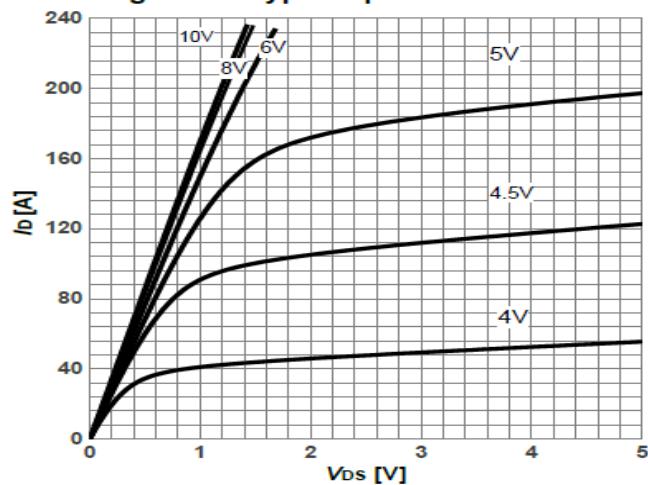


Diagram 4: Typ. transfer characteristics

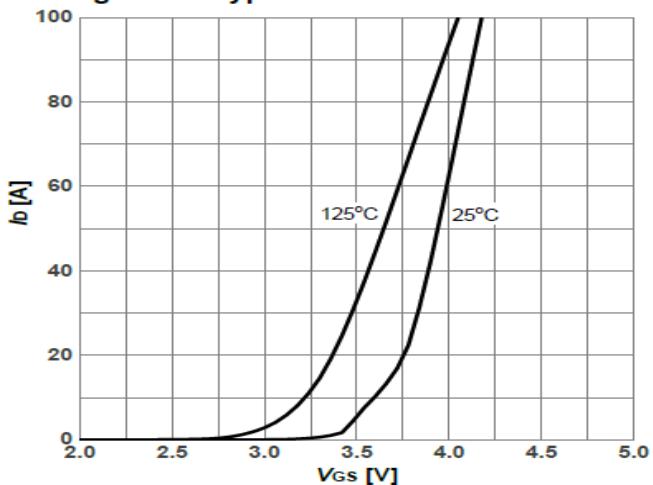


Diagram 5: Gate threshold voltage vs. Junction temperature

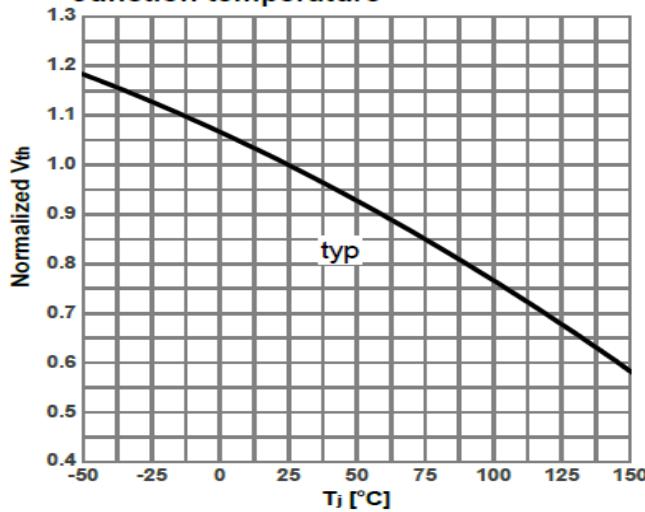


Diagram 6: On-state resistance vs. Drain current

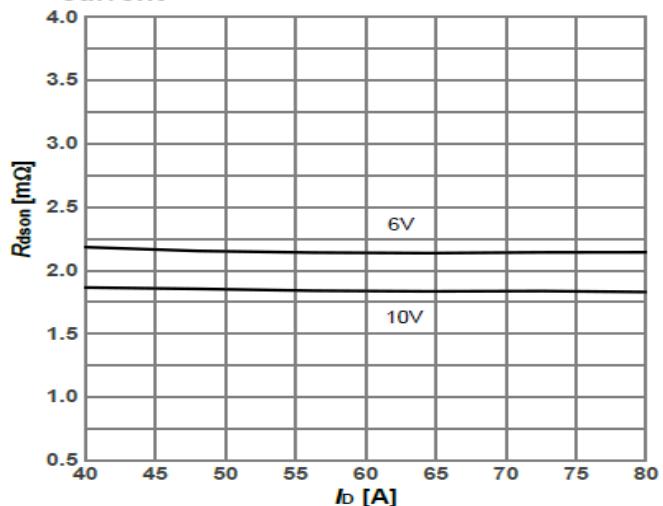
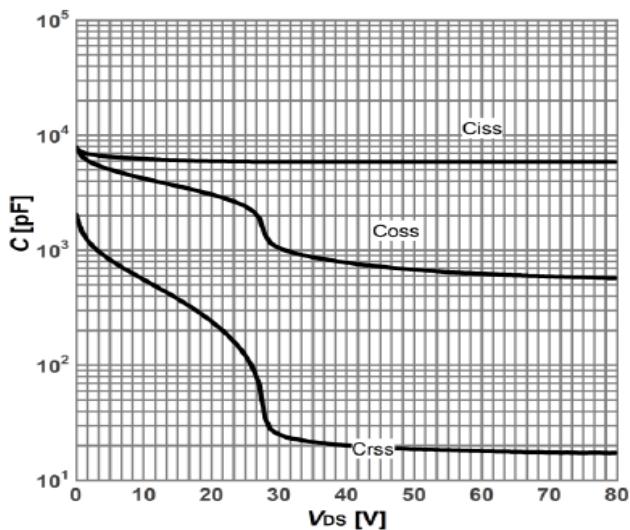
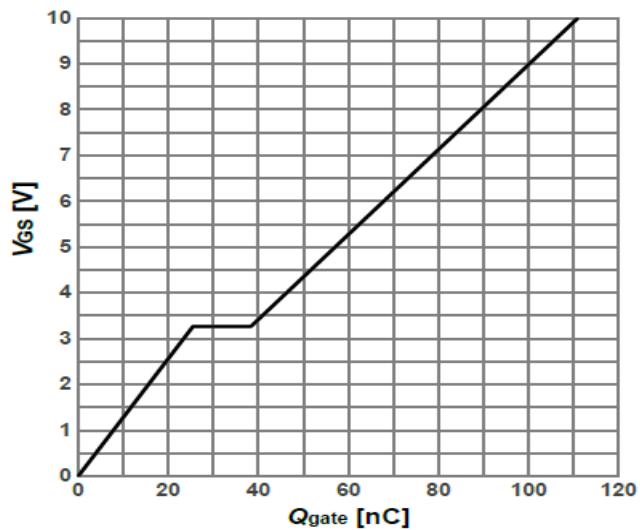
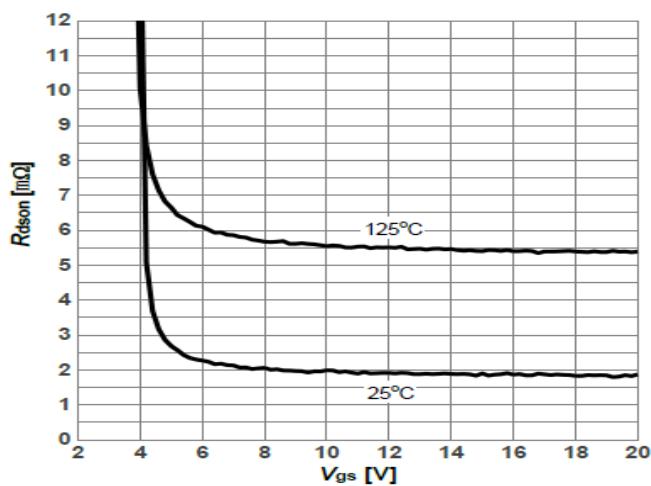
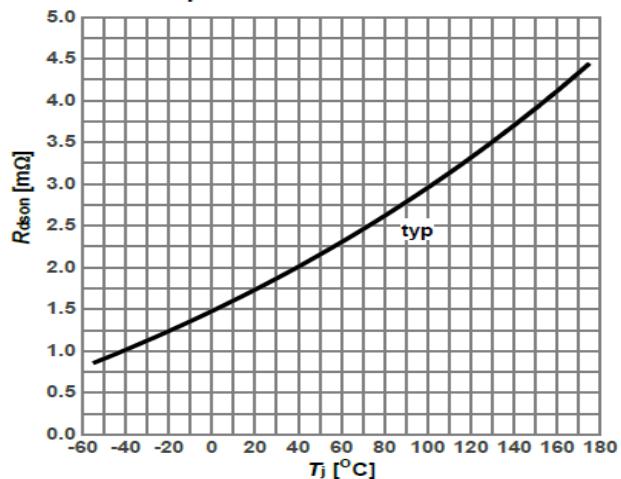
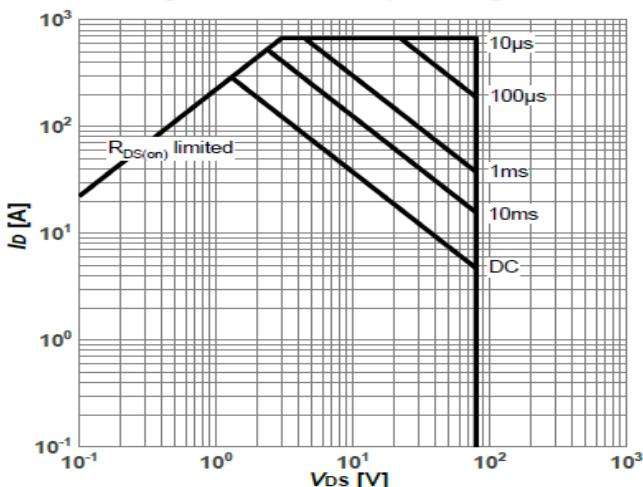
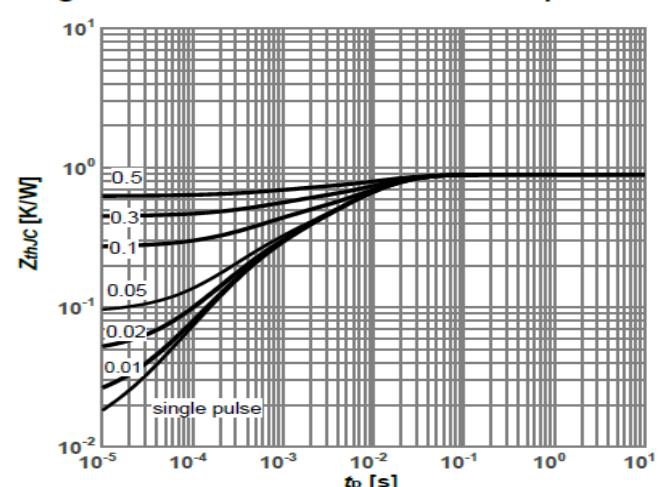
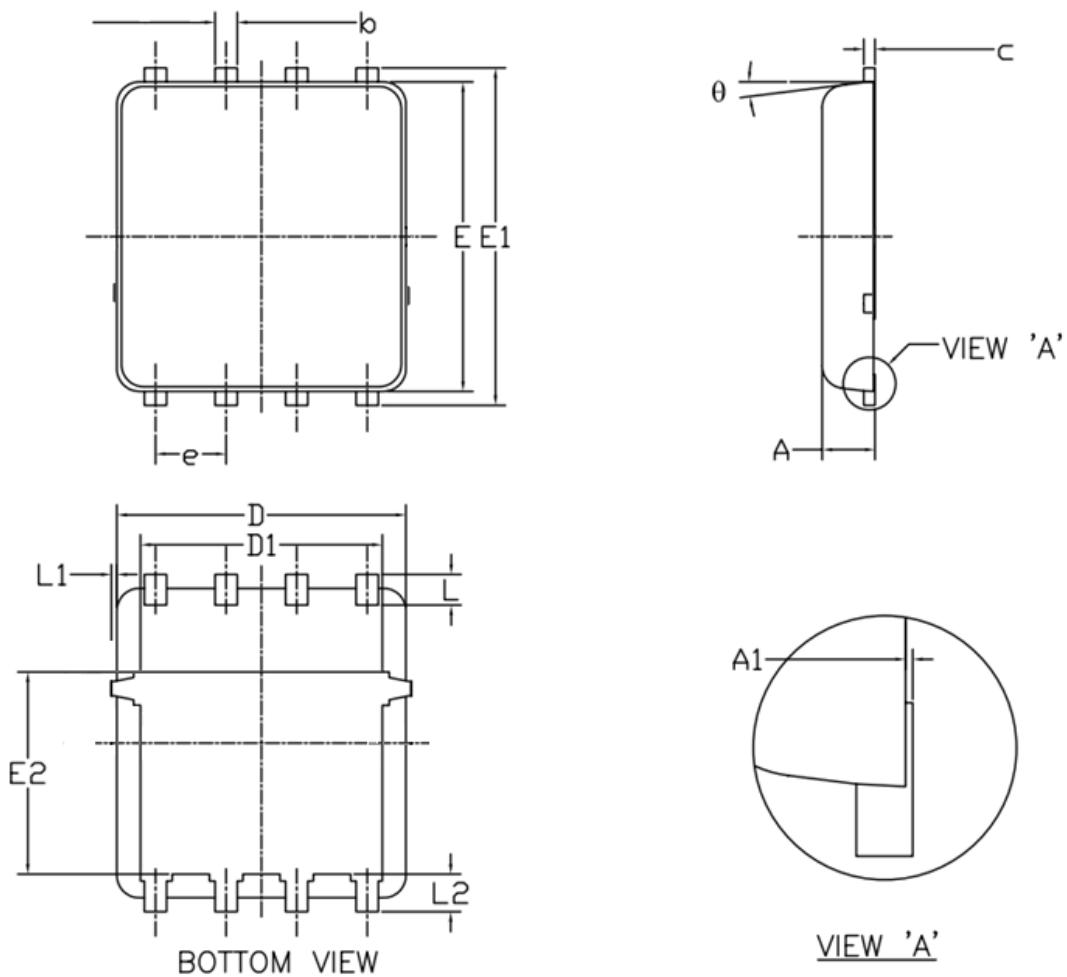


Diagram 7: Typ. capacitances

Diagram 8: Typ. gate charge

Diagram 9: On-state resistance vs. Vgs characteristics

Diagram 10: On-state resistance vs. Junction temperature

Diagram 11: Safe operating area

Diagram 12: Max. transient thermal impedance


DFN5X6-8L Package Outline Dimensions


Symbol	Dimensions (unit:mm)			Symbol	Dimensions (unit:mm)		
	Min	Typ	Max		Min	Typ	Max
A	0.90	1.00	1.20	E1	5.90	6.10	6.35
A1	0.00	--	0.05	E2	3.38	3.58	3.92
b	0.30	0.40	0.51	e	1.27 BSC		
c	0.20	0.25	0.33	L	0.51	0.61	0.71
D	4.80	4.90	5.40	L1	--	--	0.15
D1	3.61	4.00	4.25	L2	0.41	0.51	0.61
E	5.65	5.80	6.06	θ	0°	--	12°



Printing Information

ATC =====Brand

XXXXXXX =====Material Code

XXYY =====XX Representative Year
YY Representative Weeks